



DMG2305UX

## P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	Package	Ι <sub>D</sub> T <sub>A</sub> = +25°C
-20V	$52m\Omega @V_{GS} = -4.5V$	SOT23	-5.0A
-200	$100m\Omega @V_{GS} = -2.5V$	30123	-3.6A

## Description

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(ON)})$ , yet maintain superior switching performance, making it ideal for high efficiency power management applications.

# Applications

- Backlighting
- Power Management Functions
- DC-DC Converters
- Motor Control

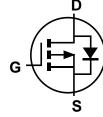
#### Features

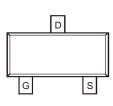
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMG2305UXQ</u>)

## **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 3
- Terminals Connections: See Diagram Below
- Weight: 0.009 grams (Approximate)







Top View



### Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMG2305UX-7	Standard	SOT23	3,000/Tape & Reel
DMG2305UX-13	Standard	SOT23	10,000/Tape & Reel

Internal Schematic

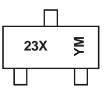
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



23X = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Key

Duie Cout	7109												
Year	2009	~	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026
Code	W	~	D	E	F	G	Н		J	K	L	М	N
													-
Mon	th	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

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## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	-20	V	
Gate-Source Voltage		V <sub>GSS</sub>	±8	V	
	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-4.2 -3.3	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-5.0 -4.0	А
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	-10	А

## **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Power Dissipation (Note 5)		PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	90	°C/W
mermar Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ hetaJA}$	64	°C/W
Thermal Resistance, Junction to Case (Note 7)		R <sub>θJC</sub>	33	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						÷
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20			V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	IDSS	_		-1.0	μA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Source Leakage	Igss	_		±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.5	—	-0.9	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
			40	52		$V_{GS} = -4.5V, I_D = -4.2A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	52	100	mΩ	V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -3.4A
	. ,		68	200		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -2A
Forward Transfer Admittance	Y <sub>FS</sub>	_	9		S	$V_{DS} = -5V, I_D = -4A$
DYNAMIC CHARACTERISTICS (Note 8)					•	• -
Input Capacitance	CISS	_	808		pF	
Output Capacitance	Coss	_	85		pF	$V_{DS} = -15V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C <sub>RSS</sub>	_	77		pF	1 = 1.00012
Gate Resistance	Rq		15.2		Ω	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V, f = 1.0MHz
SWITCHING CHARACTERISTICS (Note 8)						-
Total Gate Charge	Qg	_	10.2		nC	
Gate-Source Charge	Q <sub>gs</sub>	_	1.3		nC	$V_{GS} = -4.5V, V_{DS} = -4V,$
Gate-Drain Charge	Q <sub>gd</sub>	_	2.2		nC	$I_{\rm D} = -3.5 {\rm A}$
Turn-On Delay Time	t <sub>D(ON)</sub>	_	10.8		ns	
Turn-On Rise Time	t <sub>R</sub>	_	13.7		ns	$V_{DS} = -4V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	79.3		ns	$R_g = 6\Omega, I_D = -1A$
Turn-Off Fall Time	t <sub>F</sub>	_	34.7		ns	1 <sup>°</sup>

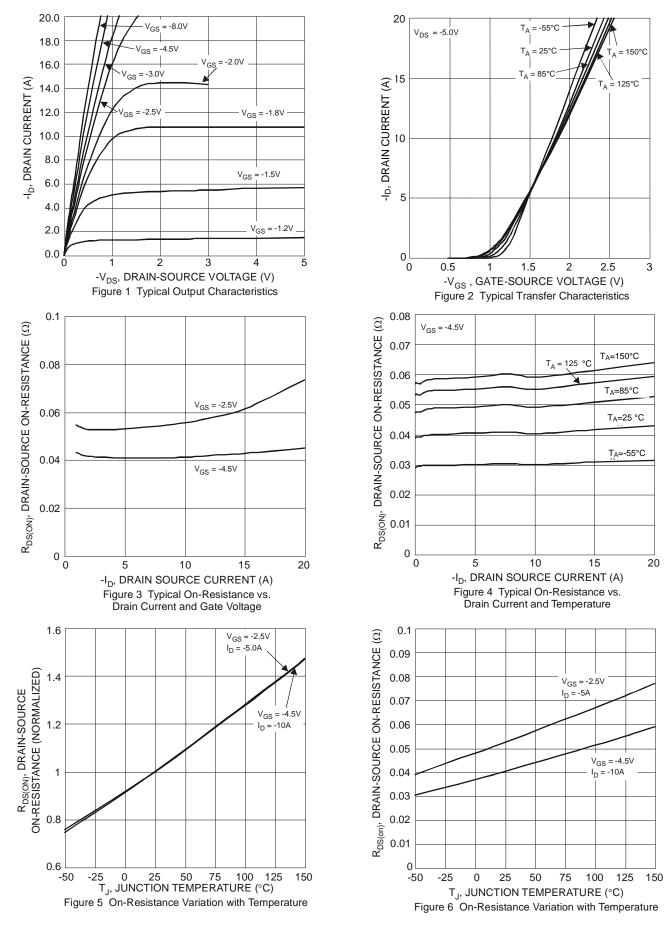
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.

Repetitive rating, pulse width limited by junction temperature.
 Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



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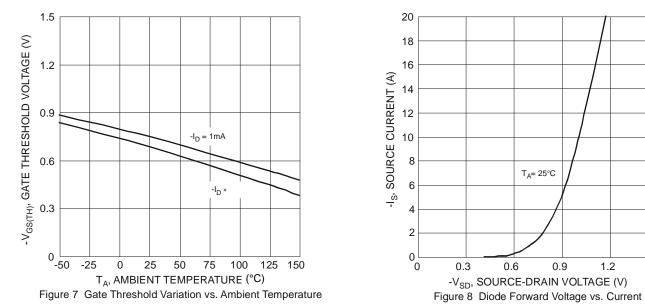
T<sub>A</sub>= 25°C

0.9

1.2

1.5

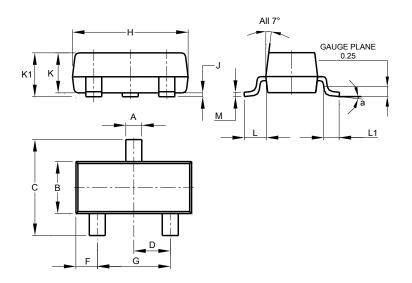
0.6





# Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

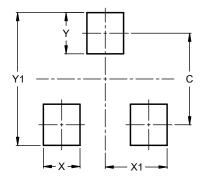


SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
в	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
κ	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
Μ	0.085	0.150	0.110			
а	0°	8°	_			
All	Dimens	ions in	mm			

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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